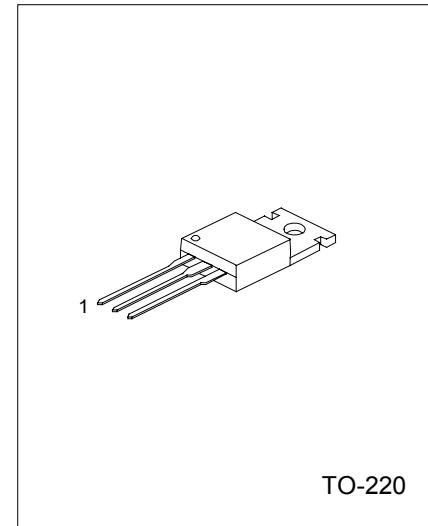
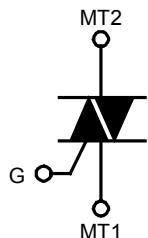


TRIACS

DESCRIPTION

Passivated triacs in a plastic envelope, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

SYMBOL



1:MT1 2:MT2 3:GATE

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATINGS	UNIT
Repetitive peak off-state voltages	V _{DRM}	600*	V
RMS on-state current full sine wave; T _{mb} ≤ 107 °C	I _T (RMS)	4	A
Non-repetitive peak on-state current (Full sine wave; T _j = 25 °C prior to surge) t = 20ms t = 16.7 ms	I _{SM}	25 27	A
I ² t for fusing t = 10 ms	I ² t	3.1	A ² s
Repetitive rate of rise of on-state current after triggering I _{RM} = 6 A; I _G = 0.2A; dI _G / dt = 0.2A/μ s	dI _T / dt T2+G+ T2+G- T2-G- T2-G+	50 50 50 10	A/μ s
Peak gate voltage	V _{GM}	5	V
Peak gate current	I _{GM}	2	A
Peak gate power	P _{GM}	5	W
Average gate power (over any 20 ms period)	P _{G(AV)}	0.5	W
Storage temperature	T _{stg}	-40 ~ 150	°C
Operating junction temperature	T _j	125	°C

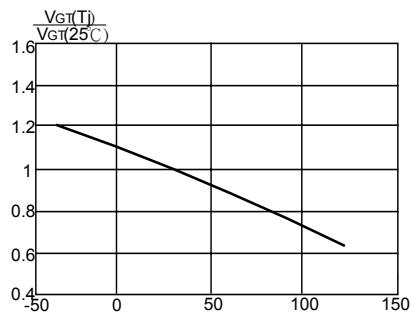
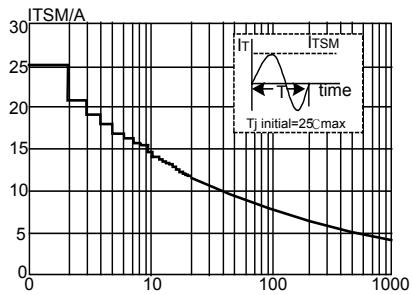
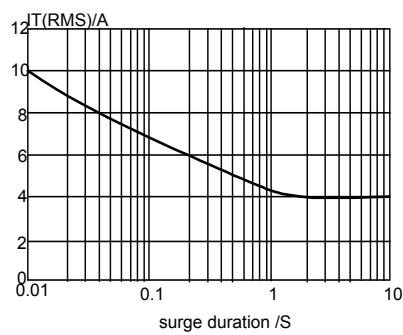
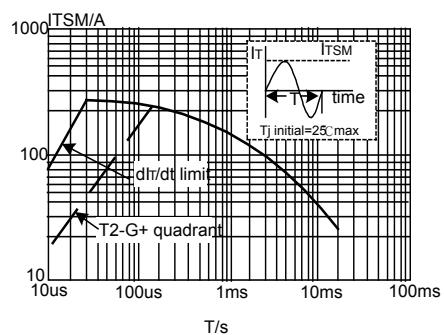
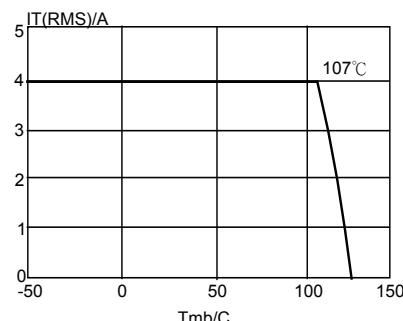
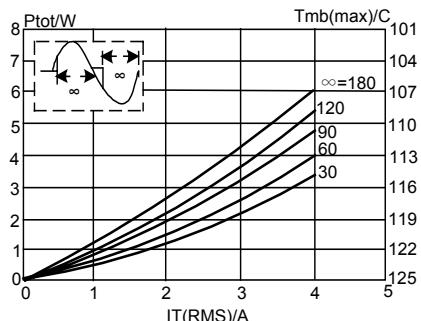
*Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 3A/μs.

THERMAL RESISTANCES

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Thermal resistance Junction to mounting base Full cycle	$R_{th\ j-mb}$			3.0	K/W
Half cycle				3.7	K/W
Thermal resistance Junction to ambient (In free air)	$R_{th\ j-a}$	60			K/W

ELECTRICAL CHARACTERISTICS ($T_j=25^\circ C$, unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
STATIC CHARACTERISTICS						
Gate trigger current	I_{GT}	$V_D = 12\ V; I_T = 0.1\ A$ T2+G+ T2+G- T2-G- T2-G+	5 8 11 30	35 35 35 70		mA
Latching current	I_L	$V_D = 12\ V; I_{GT} = 0.1\ A$ T2+G+ T2+G- T2-G- T2-G+	7 16 5 7	20 30 20 30		mA
Holding current	I_H	$V_D = 12\ V; I_{GT} = 0.1\ A$	5	15		mA
On-state voltage	V_T	$I_T = 5\ A$		1.4	1.7	V
Gate trigger voltage	V_{GT}	$V_D = 12\ V; I_T = 0.1\ A$ $V_D = 400V ; I_T = 0.1\ A;$ $T_j=125^\circ C$	0.25	0.4		V
Off-state leakage current	I_D	$V_D = V_{DRM(max)} ; T_j = 125^\circ C$		0.1	0.5	mA
DYNAMIC CHARACTERISTICS						
Critical rate of rise of Off-state voltage	dV_D / dt	$V_{DM} = 67\% V_{DRM(max)}$; $T_j = 125^\circ C$; exponential waveform; gate open circuit	100	250		V/ μ s
Critical rate of change of Commutating voltage	dV_{com}/dt	$V_{DM}=400V; T_j=95^\circ C; I_{T(RMS)}=4A;$ $dI_{com} / dt = 1.8A/ms$; gate open circuit		50		V/ μ s
Gate controlled turn-on time	t_{gt}	$I_{TM} = 6\ A; V_D = V_{DRM(max)}$; $I_G=0.1A; dI_G/dt=5A/\mus$		2		μ s



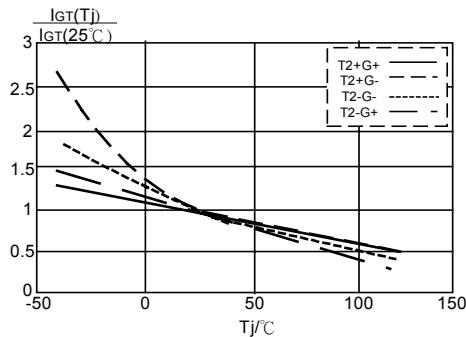


Fig. 7. Normalised gate trigger Current $I_{GT}(T_j)/I_{GT}(25^\circ C)$,versus junction temperature T_j

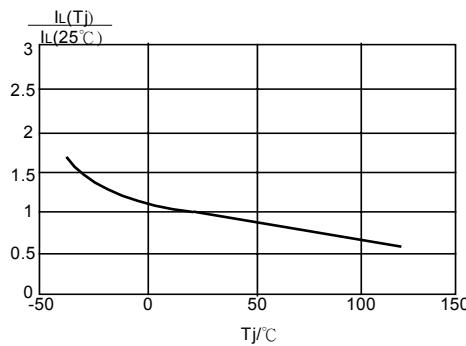


Fig.8.Normalised latching Current $I_L(T_j)/I_L(25^\circ C)$, versus junction temperature T_j

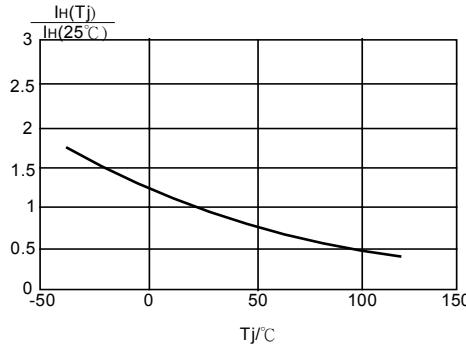


Fig. 9. Normalised holding current $I_H(T_j)/I_H(25^\circ C)$, versus junction temperature T_j

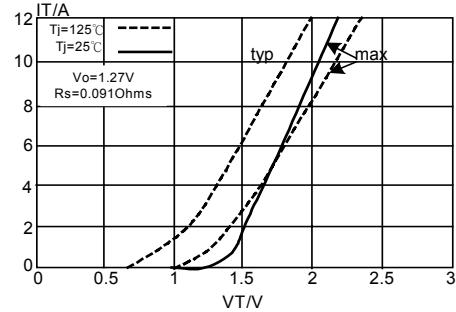


Fig.10.Typical and maximum on-state characteristic.

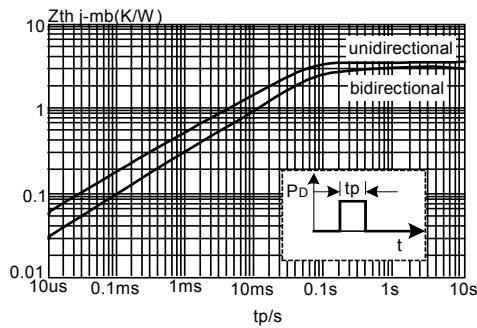


Fig.11.Transient thermal impedance $Z_{th,i-mb}$,versus pulse width t_p .

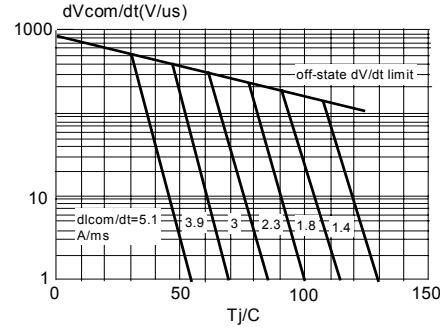


Fig.12.Typical commutation dV/dt versus junction temperature,parameter commutation dI/dt .The triac should commutate when the dV/dt is below the value on the appropriate curve for pre-commutation dI/dt

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